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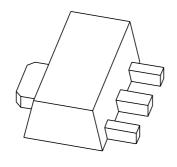
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Team Nexperia

## **DISCRETE SEMICONDUCTORS**

# DATA SHEET



**PBSS4330X** 30 V, 3 A NPN low  $V_{CEsat}$  (BISS) transistor

Product data sheet Supersedes data of 2003 Nov 28 2004 Dec 06



## 30 V, 3 A NPN low V<sub>CEsat</sub> (BISS) transistor

### **PBSS4330X**

### **FEATURES**

- SOT89 (SC-62) package
- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- $\bullet\,$  High collector current capability:  $I_C$  and  $I_{CM}$
- · Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

### **APPLICATIONS**

- · Power management
  - DC/DC converters
  - Supply line switching
  - Battery charger
  - LCD backlighting.
- · Peripheral drivers
  - Driver in low supply voltage applications (e.g. lamps and LEDs)
  - Inductive load driver (e.g. relays, buzzers and motors).

### **DESCRIPTION**

NPN low V<sub>CEsat</sub> transistor in a SOT89 plastic package.

### **MARKING**

| TYPE NUMBER | MARKING CODE(1) |
|-------------|-----------------|
| PBSS4330X   | *1R             |

### Note

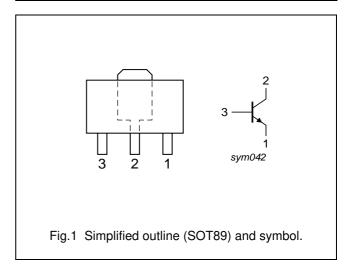
- 1. \* = p: Made in Hong Kong.
  - \* = t: Made in Malaysia.
  - \* = W: Made in China.

### **QUICK REFERENCE DATA**

| SYMBOL                                      | PARAMETER                 | MAX. | UNIT |
|---|---------------------------|------|------|
| V <sub>CEO</sub>                            | collector-emitter voltage | 30   | ٧    |
| I <sub>C</sub>                              | collector current (DC)    | 3    | Α    |
| I <sub>CM</sub> peak collector current      |                           | 5    | Α    |
| R <sub>CEsat</sub> equivalent on-resistance |                           | 100  | mΩ   |

### **PINNING**

| PIN | DESCRIPTION |  |
|-----|-------------|--|
| 1   | emitter     |  |
| 2   | collector   |  |
| 3   | base        |  |



### **ORDERING INFORMATION**

| TYPE NUMBER |       | PACKAGE  |         |
|-------------|-------|--|---------|
|             |       | DESCRIPTION  | VERSION |
| PBSS4330X   | SC-62 | plastic surface mounted package; collector pad for good heat transfer; 3 leads | SOT89   |

# 30 V, 3 A NPN low $V_{CEsat}$ (BISS) transistor

PBSS4330X

### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

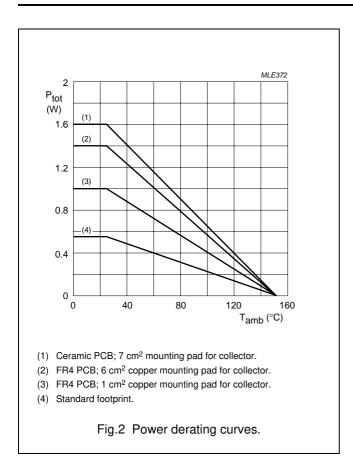
| SYMBOL           | PARAMETER                 | CONDITIONS                     | MIN. | MAX. | UNIT |
|------------------|---------------------------|--------------------------------|------|------|------|
| V <sub>CBO</sub> | collector-base voltage    | open emitter                   | _    | 50   | ٧    |
| $V_{CEO}$        | collector-emitter voltage | open base                      | -    | 30   | ٧    |
| V <sub>EBO</sub> | emitter-base voltage      | open collector                 | _    | 6    | ٧    |
| Ic               | collector current (DC)    | note 4                         | -    | 3    | Α    |
| I <sub>CM</sub>  | peak collector current    | limited by T <sub>j(max)</sub> | -    | 5    | Α    |
| I <sub>B</sub>   | base current (DC)         |                                | _    | 0.5  | Α    |
| P <sub>tot</sub> | total power dissipation   | T <sub>amb</sub> ≤ 25 °C       |      |      |      |
|                  |                           | note 1                         | _    | 550  | mW   |
|                  |                           | note 2                         | _    | 1    | W    |
|                  |                           | note 3                         | _    | 1.4  | W    |
|                  |                           | note 4                         | _    | 1.6  | W    |
| T <sub>stg</sub> | storage temperature       |                                | -65  | +150 | °C   |
| Tj               | junction temperature      |                                | _    | 150  | °C   |
| T <sub>amb</sub> | ambient temperature       |                                | -65  | +150 | °C   |

### **Notes**

- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
- 4. Device mounted on a ceramic printed-circuit board 7 cm<sup>2</sup>, single-sided copper, tin-plated.

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# 30 V, 3 A NPN low $V_{CEsat}$ (BISS) transistor

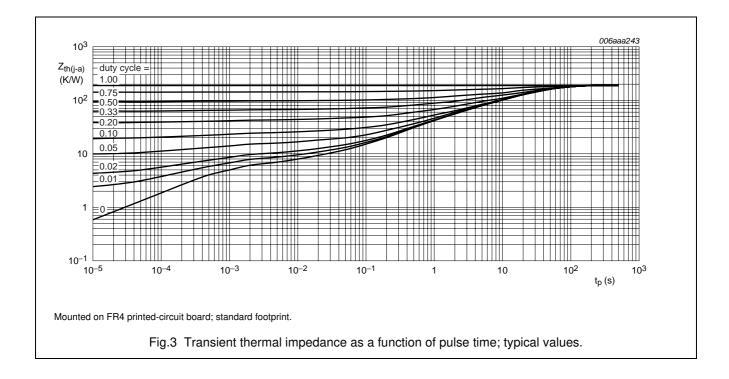
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### THERMAL CHARACTERISTICS

| SYMBOL               | PARAMETER   | CONDITIONS  | VALUE | UNIT |
|----------------------|---|-------------|-------|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient         | in free air |       |      |
|                      |   | note 1      | 225   | K/W  |
|                      |   | note 2      | 125   | K/W  |
|                      |   | note 3      | 90    | K/W  |
|                      |   | note 4      | 80    | K/W  |
| R <sub>th(j-s)</sub> | thermal resistance from junction to soldering point |             | 16    | K/W  |

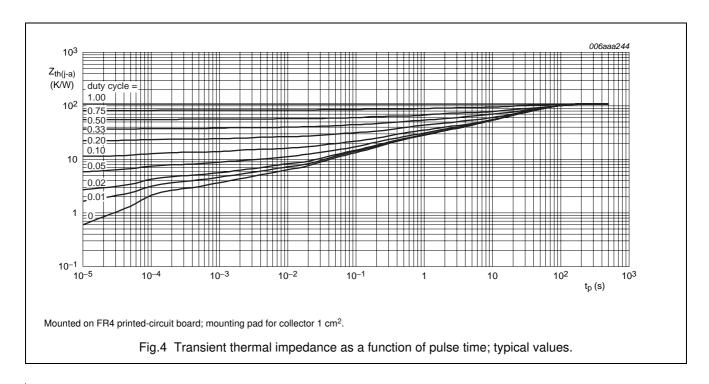
### **Notes**

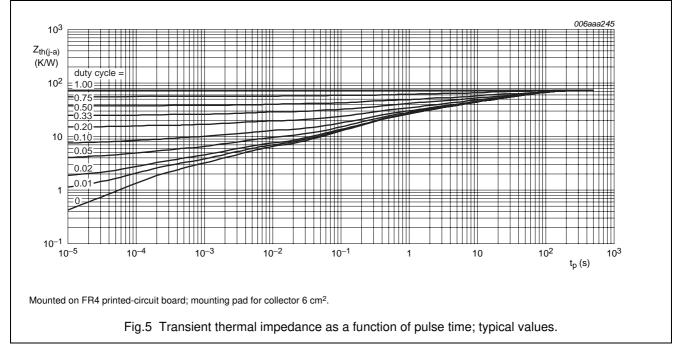
- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
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# 30 V, 3 A NPN low $V_{CEsat}$ (BISS) transistor

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### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

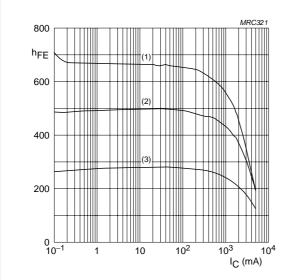
| SYMBOL             | PARAMETER                         | CONDITIONS  | MIN. | TYP. | MAX. | UNIT |
|--------------------|-----------------------------------|---|------|------|------|------|
| I <sub>CBO</sub>   | collector-base cut-off current    | V <sub>CB</sub> = 30 V; I <sub>E</sub> = 0 A                          | _    | _    | 100  | nA   |
|                    |                                   | V <sub>CB</sub> = 30 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C | _    | _    | 50   | μΑ   |
| I <sub>CES</sub>   | collector-emitter cut-off current | V <sub>CE</sub> = 30 V; V <sub>BE</sub> = 0 V                         | -    | _    | 100  | nA   |
| I <sub>EBO</sub>   | emitter-base cut-off current      | V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A                           | -    | _    | 100  | nA   |
| h <sub>FE</sub>    | DC current gain                   | V <sub>CE</sub> = 2 V   |      |      |      |      |
|                    |                                   | I <sub>C</sub> = 0.1 A  | 300  | _    | _    |      |
|                    |                                   | $I_{\rm C} = 0.5  {\rm A}$  | 300  | _    | _    |      |
|                    |                                   | I <sub>C</sub> = 1 A; note 1  | 270  | _    | 700  |      |
|                    |                                   | I <sub>C</sub> = 2 A; note 1  | 230  | _    | -    |      |
|                    |                                   | I <sub>C</sub> = 3 A; note 1  | 180  | _    | _    |      |
| V <sub>CEsat</sub> | collector-emitter saturation      | I <sub>C</sub> = 0.5 A; I <sub>B</sub> = 50 mA                        | _    | _    | 60   | mV   |
|                    | voltage                           | I <sub>C</sub> = 1 A; I <sub>B</sub> = 50 mA                          | -    | _    | 110  | mV   |
|                    |                                   | I <sub>C</sub> = 2 A; I <sub>B</sub> = 100 mA                         | -    | _    | 220  | mV   |
|                    |                                   | $I_C = 3 A$ ; $I_B = 300 mA$ ; note 1                                 | -    | _    | 300  | mV   |
| R <sub>CEsat</sub> | equivalent on-resistance          | I <sub>C</sub> = 3 A; I <sub>B</sub> = 300 mA; note 1                 | -    | 80   | 100  | mΩ   |
| V <sub>BEsat</sub> | base-emitter saturation voltage   | I <sub>C</sub> = 2 A; I <sub>B</sub> = 100 mA                         | _    | _    | 1.1  | V    |
|                    |                                   | I <sub>C</sub> = 3 A; I <sub>B</sub> = 300 mA; note 1                 | _    | _    | 1.2  | V    |
| V <sub>BEon</sub>  | base-emitter turn-on voltage      | V <sub>CE</sub> = 2 V; I <sub>C</sub> = 1 A                           | 1.0  | _    | _    | V    |
| f <sub>T</sub>     | transition frequency              | $I_C = 100 \text{ mA}; V_{CE} = 5 \text{ V}; f = 100 \text{ MHz}$     | 100  | _    | -    | MHz  |
| C <sub>c</sub>     | collector capacitance             | $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$   | _    | _    | 30   | pF   |

### Note

1. Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

# 30 V, 3 A NPN low $V_{CEsat}$ (BISS) transistor

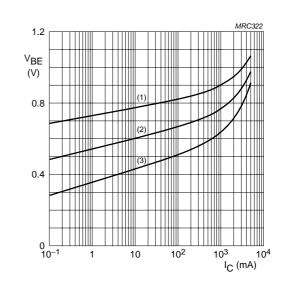
## PBSS4330X



 $V_{CE} = 2 V$ .

- (1)  $T_{amb} = 100 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

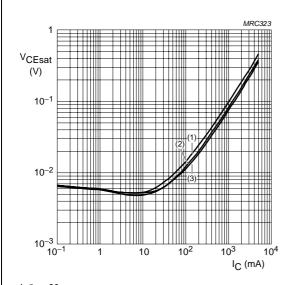
Fig.6 DC current gain as a function of collector current; typical values.



 $V_{CE} = 2 V$ .

- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 100 \, ^{\circ}C$ .

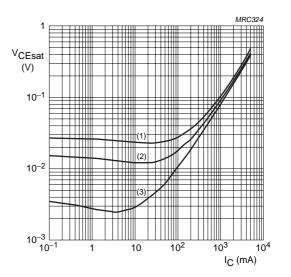
Fig.7 Base-emitter voltage as a function of collector current; typical values.



 $I_{C}/I_{B} = 20.$ 

- (1)  $T_{amb} = 100 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C.$

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



 $T_{amb}$  = 25 °C.

- (1)  $I_C/I_B = 100$
- (2)  $I_C/I_B = 50$ .
- (3)  $I_C/I_B = 10$ .

Fig.9 Collector-emitter saturation voltage as a function of collector current; typical values.

# 30 V, 3 A NPN low $V_{CEsat}$ (BISS) transistor

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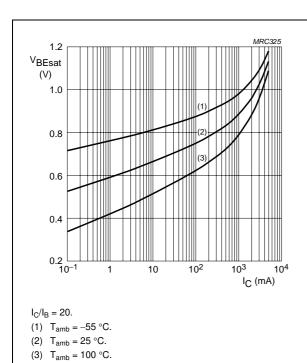
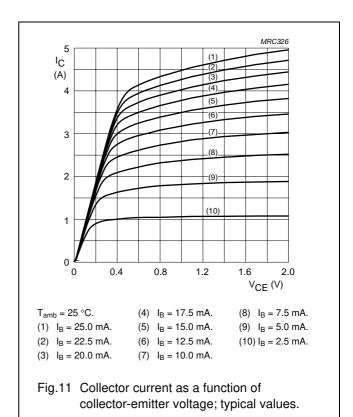
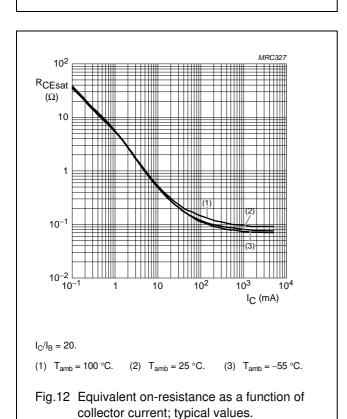
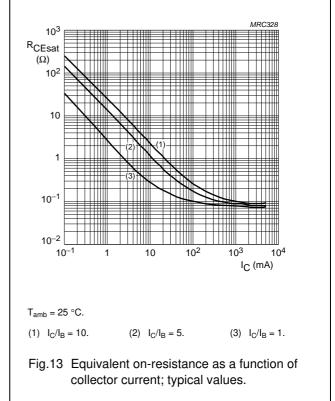


Fig.10 Base-emitter saturation voltage as a function of collector current; typical values.







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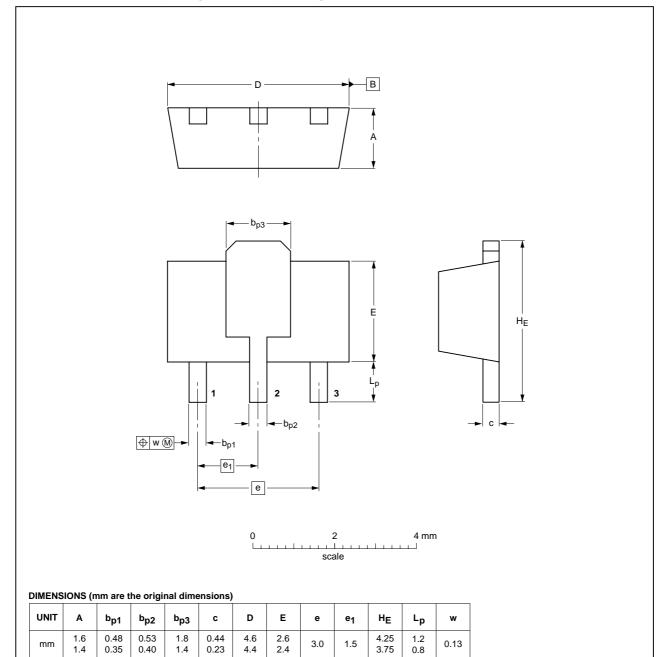
30 V, 3 A NPN low  $V_{CEsat}$  (BISS) transistor

PBSS4330X

### **PACKAGE OUTLINE**

### Plastic surface-mounted package; collector pad for good heat transfer; 3 leads

SOT89



| OUTLINE | RI  |        | REFERENCES |  |            | ISSUE DATE                      |
|---------|-----|--------|------------|--|------------|---------------------------------|
| VERSION | IEC | JEDEC  | JEITA      |  | PROJECTION | ISSUE DATE                      |
| SOT89   |     | TO-243 | SC-62      |  |            | <del>04-08-03</del><br>06-03-16 |

## 30 V, 3 A NPN low V<sub>CEsat</sub> (BISS) transistor

PBSS4330X

### **DATA SHEET STATUS**

| DOCUMENT<br>STATUS(1)  | PRODUCT<br>STATUS <sup>(2)</sup> | DEFINITION  |
|------------------------|----------------------------------|---|
| Objective data sheet   | Development                      | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification                    | This document contains data from the preliminary specification.                       |
| Product data sheet     | Production                       | This document contains the product specification.                                     |

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